# **MOSFET** – Power, Single P-Channel -60 V, -14 A, 52 m $\Omega$

#### Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFS5116PLWF Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

|  | (.) =0              |                                   | nee neted)       |  |      |
|--|---------------------|-----------------------------------|------------------|--|------|
| Parar  | neter               |                                   | Symbol           | Value  | Unit |
| Drain-to-Source Voltag   | е                   |                                   | V <sub>DSS</sub> | -60  | V    |
| Gate-to-Source Voltage   | Э                   |                                   | V <sub>GS</sub>  | ±20  | V    |
| Continuous Drain Cur-  |                     | $T_{mb} = 25^{\circ}C$            | ۱ <sub>D</sub>   | -14  | А    |
| rent R <sub>ΨJ-mb</sub> (Notes 1,<br>2, 3, 4)  | Steady<br>State     | $T_{mb} = 100^{\circ}C$           |                  | -10  |      |
| Power Dissipation  |                     | T <sub>mb</sub> = 25°C            | PD               | 21   | W    |
| $R_{\Psi J-mb}$ (Notes 1, 2, 3)  |                     | $T_{mb} = 100^{\circ}C$           |                  | 10   |      |
| Continuous Drain Cur-  | Steady              | T <sub>A</sub> = 25°C             | ۱ <sub>D</sub>   | -6   | А    |
| rent $R_{\theta JA}$ (Notes 1 & 3, 4)  |                     | $T_A = 100^{\circ}C$              |                  | -4   |      |
| Power Dissipation  | State               | T <sub>A</sub> = 25°C             | PD               | -10<br>21<br>10<br>-6<br>-4<br>3.2<br>1.6<br>-126<br>-55 to<br>+175<br>-17 | W    |
| R <sub>θJA</sub> (Notes 1, 3)  |                     | T <sub>A</sub> = 100°C            |                  | 1.6  |      |
| Pulsed Drain Current   | T <sub>A</sub> = 25 | °C, t <sub>p</sub> = 10 μs        | I <sub>DM</sub>  | -126   | А    |
| Operating Junction and Storage Temperature   |                     | T <sub>J</sub> , T <sub>stg</sub> |                  | °C   |      |
| Source Current (Body Diode)  |                     |                                   | ۱ <sub>S</sub>   | -17  | А    |
| Single Pulse Drain-to-Source Avalanche<br>Energy (T <sub>J</sub> = 25°C, V <sub>DD</sub> = 50 V, V <sub>GS</sub> = 10 V,<br>$I_{L(pk)}$ = 30 A, L = 0.1 mH, R <sub>G</sub> = 25 $\Omega$ ) |                     | E <sub>AS</sub>                   | 45               | mJ   |      |
| Lead Temperature for S<br>(1/8" from case for 10 s)  |                     | Purposes                          | ΤL               | 260  | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

| Parameter   | Symbol          | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Mounting Board (top) – Steady<br>State (Note 2 and 3) | $R_{\Psi J-mb}$ | 7.2   | °C/W |
| Junction-to-Ambient - Steady State (Note 3)                       | $R_{\theta JA}$ | 47    |      |

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

- 2. Psi  $(\Psi)$  is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

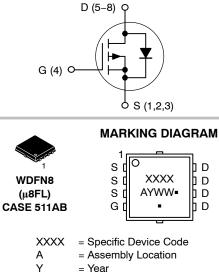


## **ON Semiconductor®**

#### http://onsemi.com

| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub> MAX | I <sub>D</sub> MAX |
|----------------------|-------------------------|--------------------|
| –60 V                | 52 m $\Omega$ @ –10 V   | –14 A              |
| -00 V                | 72 mΩ @ –4.5 V          | -14 A              |

**P-Channel MOSFET** 



WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

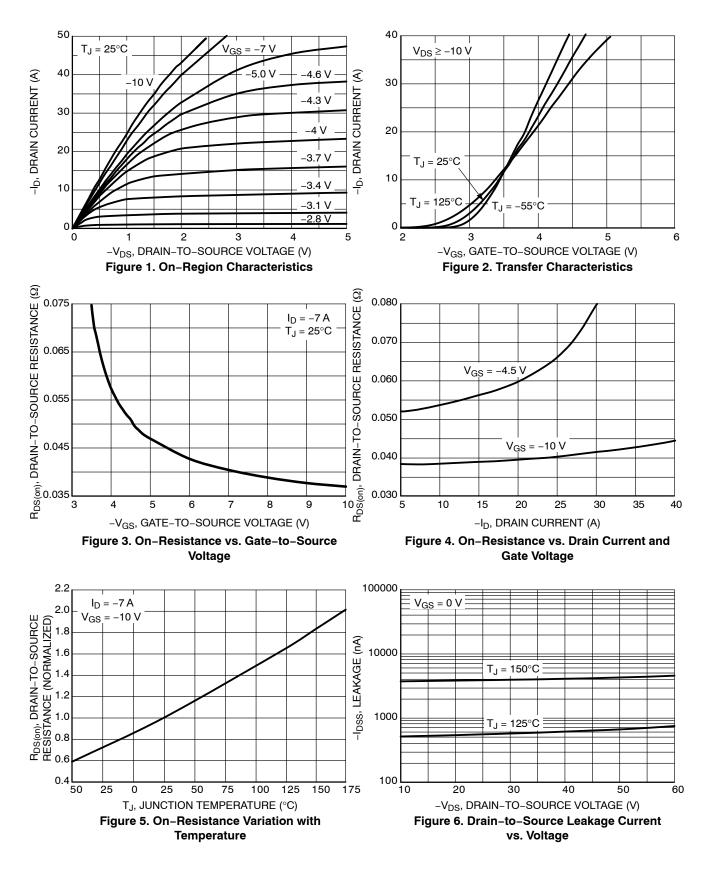
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

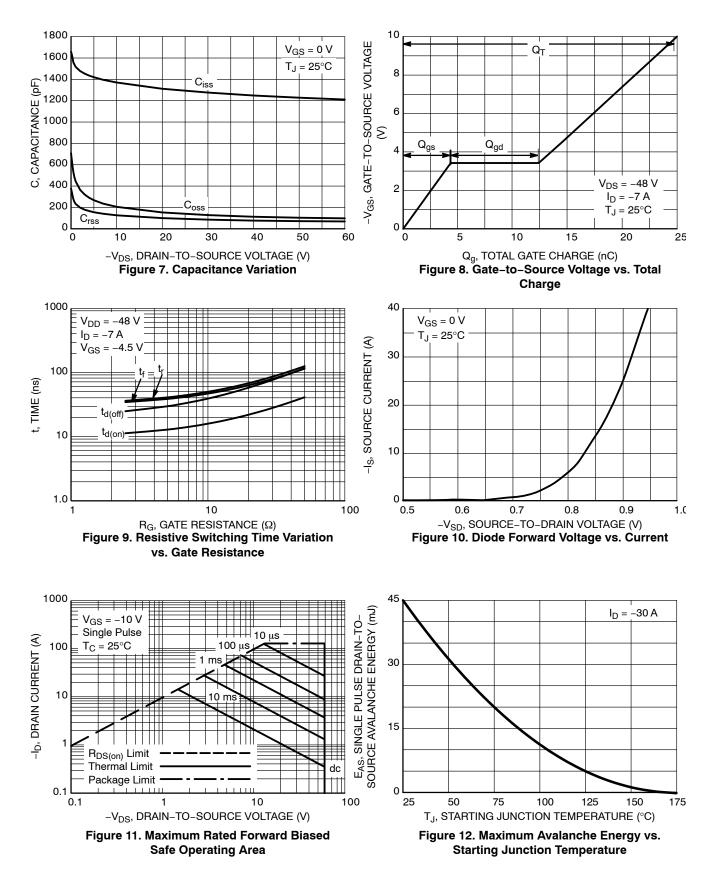
| Parameter                         | Symbol               | Test Condition  |                        | Min | Тур   | Max   | Unit |
|-----------------------------------|----------------------|---|------------------------|-----|-------|-------|------|
| OFF CHARACTERISTICS               |                      |   |                        |     | •     |       | -    |
| Drain-to-Source Breakdown Voltage | V <sub>(BR)DSS</sub> | $V_{GS}$ = 0 V, I <sub>D</sub>                        | = 250 μA               | -60 |       |       | V    |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>     | V <sub>GS</sub> = 0 V,                                | $T_J = 25^{\circ}C$    |     |       | -1.0  | μA   |
|                                   |                      | $V_{DS} = 60 V$                                       | T <sub>J</sub> = 125°C |     |       | -10   |      |
| Gate-to-Source Leakage Current    | I <sub>GSS</sub>     | $V_{DS}$ = 0 V, $V_{G}$                               | <sub>S</sub> = ±20 V   |     |       | ±100  | nA   |
| ON CHARACTERISTICS (Note 5)       |                      |   |                        |     |       |       |      |
| Gate Threshold Voltage            | V <sub>GS(TH)</sub>  | $V_{GS} = V_{DS}, I_D$                                | = -250 μA              | -1  |       | -3    | V    |
| Drain-to-Source On Resistance     | R <sub>DS(on)</sub>  | V <sub>GS</sub> = -10 V,                              | I <sub>D</sub> = -7 A  |     | 37    | 52    | mΩ   |
|                                   |                      | V <sub>GS</sub> = -4.5 V                              | I <sub>D</sub> = -7 A  |     | 51    | 72    |      |
| Forward Transconductance          | 9 <sub>FS</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = -5 A         |                        |     | 11    |       | S    |
| CHARGES AND CAPACITANCES          |                      |   |                        |     |       |       |      |
| Input Capacitance                 | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, f = 1.0 MHz,                   |                        |     | 1258  |       | pF   |
| Output Capacitance                | C <sub>oss</sub>     | V <sub>DS</sub> = -                                   | 25 V                   |     | 127   |       | 1    |
| Reverse Transfer Capacitance      | C <sub>rss</sub>     |   |                        |     | 84    |       | 1    |
| Total Gate Charge                 | Q <sub>G(TOT)</sub>  |   |                        |     | 14    |       | nC   |
| Threshold Gate Charge             | Q <sub>G(TH)</sub>   | $V_{GS}$ = -4.5 V, $V_{DS}$ = -48 V, $I_{D}$ = -7 A   |                        |     | 1     |       | nC   |
| Gate-to-Source Charge             | Q <sub>GS</sub>      |   |                        |     | 4     |       | 1    |
| Gate-to-Drain Charge              | Q <sub>GD</sub>      |   |                        |     | 8     |       | 1    |
| Total Gate Charge                 | Q <sub>G(TOT)</sub>  | $V_{GS} = -10$ V, $V_{DS} = -48$ V,<br>$I_{D} = -7$ A |                        |     | 25    |       | nC   |
| SWITCHING CHARACTERISTICS (No     | te 6)                |   |                        |     |       |       |      |
| Turn-On Delay Time                | t <sub>d(on)</sub>   |   |                        |     | 14    |       | ns   |
| Rise Time                         | t <sub>r</sub>       | V <sub>GS</sub> = -4.5 V. V                           | ns = −48 V.            |     | 68    |       | _    |
| Turn–Off Delay Time               | t <sub>d(off)</sub>  | V <sub>GS</sub> = -4.5 V, V<br>I <sub>D</sub> = -7    | 7 A                    |     | 24    |       |      |
| Fall Time                         | t <sub>f</sub>       |   |                        |     | 36    |       | 1    |
| DRAIN-SOURCE DIODE CHARACTER      | ISTICS               |   |                        |     | •     | -     | -    |
| Forward Diode Voltage             | V <sub>SD</sub>      | V <sub>GS</sub> = 0 V,                                | $T_J = 25^{\circ}C$    |     | -0.79 | -1.20 | V    |
|                                   |                      | I <sub>S</sub> = -7 A                                 | T <sub>J</sub> = 125°C |     | -0.64 |       | 1    |
| Reverse Recovery Time             | t <sub>RR</sub>      |   |                        |     | 21    |       | ns   |
| Charge Time                       | ta                   | V <sub>GS</sub> = 0 V, dl <sub>S</sub> /d             | t = 100 A/us.          |     | 16    |       | 1    |
| Discharge Time                    | t <sub>b</sub>       | $I_{\rm S} = -7$                                      | 7 A                    |     | 5     |       | 1    |
| Reverse Recovery Charge           | Q <sub>RR</sub>      |   |                        |     | 24    |       | nC   |

5. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%. 6. Switching characteristics are independent of operating junction temperatures.

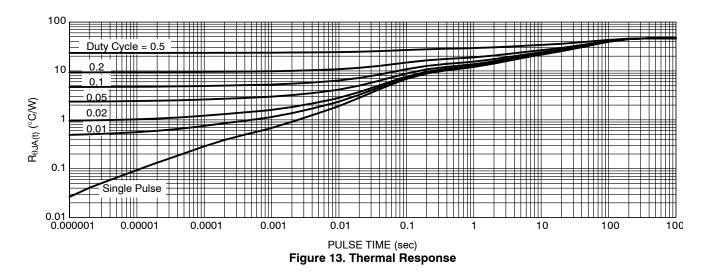
## **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**



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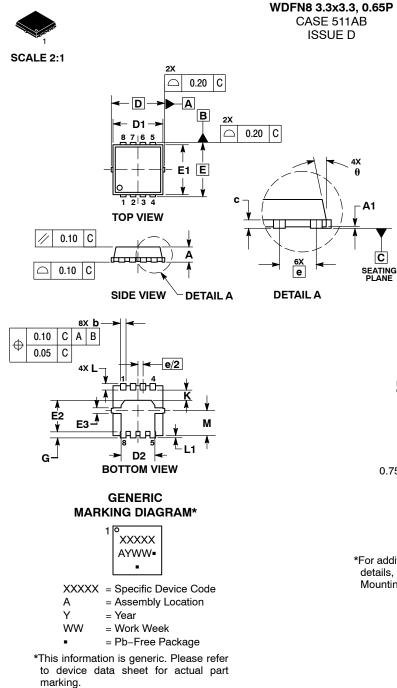
#### **DEVICE ORDERING INFORMATION**

| Device           | Marking | Package            | Shipping <sup>†</sup> |
|------------------|---------|--------------------|-----------------------|
| NVTFS5116PLTAG   | 5116    | WDFN8<br>(Pb-Free) | 1500 / Tape & Reel    |
| NVTFS5116PLWFTAG | 16LW    | WDFN8<br>(Pb-Free) | 1500 / Tape & Reel    |
| NVTFS5116PLTWG   | 5116    | WDFN8<br>(Pb-Free) | 5000 / Tape & Reel    |
| NVTFS5116PLWFTWG | 16LW    | WDFN8<br>(Pb-Free) | 5000 / Tape & Reel    |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DATE 23 APR 2012





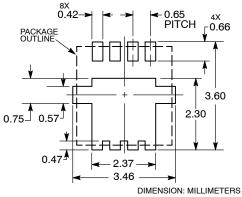
Pb-Free indicator, "G" or microdot " .", may or may not be present.

NOTES: LES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. 1.

2. 3.

|     | MILLIMETERS |          |      | INCHES    |           |       |  |
|-----|-------------|----------|------|-----------|-----------|-------|--|
| DIM | MIN         | NOM      | MAX  | MIN       | NOM       | MAX   |  |
| Α   | 0.70        | 0.75     | 0.80 | 0.028     | 0.030     | 0.031 |  |
| A1  | 0.00        |          | 0.05 | 0.000     |           | 0.002 |  |
| b   | 0.23        | 0.30     | 0.40 | 0.009     | 0.012     | 0.016 |  |
| с   | 0.15        | 0.20     | 0.25 | 0.006     | 0.008     | 0.010 |  |
| D   |             | 3.30 BSC |      | 0         | 0.130 BSC |       |  |
| D1  | 2.95        | 3.05     | 3.15 | 0.116     | 0.120     | 0.124 |  |
| D2  | 1.98        | 2.11     | 2.24 | 0.078     | 0.083     | 0.088 |  |
| E   |             | 3.30 BSC |      | 0.130 BSC |           |       |  |
| E1  | 2.95        | 3.05     | 3.15 | 0.116     | 0.120     | 0.124 |  |
| E2  | 1.47        | 1.60     | 1.73 | 0.058     | 0.063     | 0.068 |  |
| E3  | 0.23        | 0.30     | 0.40 | 0.009     | 0.012     | 0.016 |  |
| е   |             | 0.65 BSC |      |           | 0.026 BSC |       |  |
| G   | 0.30        | 0.41     | 0.51 | 0.012     | 0.016     | 0.020 |  |
| к   | 0.65        | 0.80     | 0.95 | 0.026     | 0.032     | 0.037 |  |
| L   | 0.30        | 0.43     | 0.56 | 0.012     | 0.017     | 0.022 |  |
| L1  | 0.06        | 0.13     | 0.20 | 0.002     | 0.005     | 0.008 |  |
| м   | 1.40        | 1.50     | 1.60 | 0.055     | 0.059     | 0.063 |  |
| θ   | 0 °         |          | 12 ° | 0 °       |           | 12 °  |  |

SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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